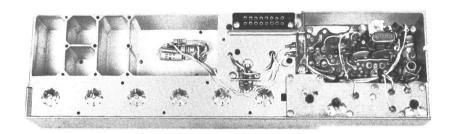


# 132—174 MHZ DUAL FRONT END MODELS 19D413151-G1—G4



# **SPECIFICATIONS**

DUAL FRONT END 19D413151-G1 thru -G4

FREQUENCY RANGE

132-174 MHz

SENSITIVITY

with one Antenna	with Two Antenna
0.50 microvolt 0.65 microvolt	0.45 microvolt 0.60 microvolt
-80 dB	

INTERMODULATION (EIA)

12-dB SINAD 20-dB quieting

FREQUENCY STABILITY

TRANSISTORS

INPUT POWER

.010 Amps at 10 volts

.0005% (-30°C to +60°C)

5

DIMENSIONS (HxWxD) 2-1/4" x 11-3/4" x 4-3/8"

\*These specifications are intended primarily for the use of the serviceman. Refer to the appropriate Specification Sheet for the complete specifications.

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#### **DESCRIPTION**

#### DUAL FRONT END (DFE)

General Electric Dual Front End Model 19D413151-Gl through -G4 was designed for operation in the 132-174 megahertz band. The Dual Front End (DFE) is used with MASTR Progress Line Receivers to monitor two frequencies when the channel spacing is greater than 0.4% ( $\pm.2\%$ ).

The DFE is of single-unit construction, completely housed in an aluminum casting for maximum shielding and rigidity. The unit consists of five helical resonators, lst mixer, oscillator and two multiplier stages, and a high IF amplifier. The output feeds directly into the receiver crystal filter as shown in Figure 1. The chassis is mounted in a housing on the rear of the mobile frame, adding approximately three inches to the overall length of the mobile unit.

#### ANTENNA SYSTEMS

The Dual Front End and the receiver may use a common antenna or separate antennas. If the two frequencies are in the 132-174 megahertz range, one antenna will work satisfactorily. For crossband applications, where the receiver frequency is in the 25-50 megahertz range and the DFE in the 132-174 megahertz range, two antennas must be used to obtain maximum receiver sensitivity. The frequency range and antenna system used with each model DFE is shown in the following chart.

DUAL	FREQUENCY	ANTENNA			
FRONT END	RANGE	SYSTEM			
19D413151-G2 19D413151-G3	132-150.8 MHz 150.8-174 MHz 132-150.8 MHz 150.8-174 MHz	<b>O</b> ne Antenna Two Antennas			

#### Single Antenna System (Figure 2)

In the single antenna system, the antenna connects to jack J901 on the front of the mobile unit. From J901, the antenna connects to the common terminal of antenna relay K901. The transmitter connects to the normally open contact terminal of the antenna relay. The normally closed contact terminal of K901 is connected to the common terminal of the antenna "T" connector. One cable from the "T" connector goes to J1 on the Dual Front End and the other cable goes to J441 on the receiver.

#### Dual Antenna System (Figure 3)

When two antennas are used, one antenna is connected through antenna jack J902 on the front of the mobile unit to jack J1 on the DFE. The second antenna is connected through J901 to the common terminal of antenna relay K901. The normally closed relay contact is connected to receiver antenna jack J441, and the normally open contact is connected to the transmitter.

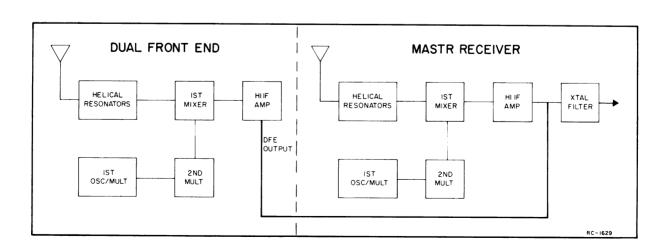


Figure 1 - Dual Front End Block Diagram

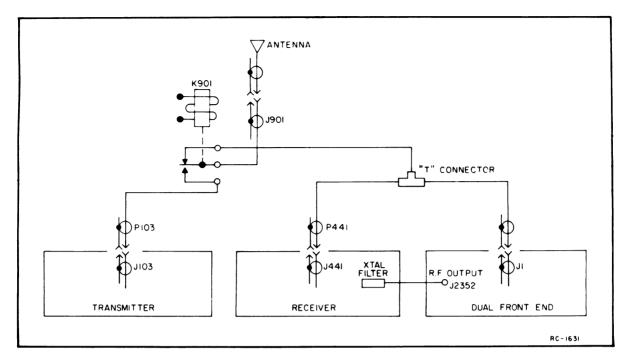


Figure 2 - Single Antenna Block Diagram

### **CIRCUIT ANALYSIS**

#### DUAL FRONT END

The MASTP Progress Line Dual Front End is completed, transistorized, using five silicon transistors. A regulated 10 volts is used for all stages of the Dual Front End.

Centralized metering jack J2351 is provided for use with GE Test Set Models 4EX3A10 and 4EX8K10, 11 for ease of alignment and servicing. The Test Set meters the oscillator, multipliers, and the regulated 10 volts.

#### Helical Resonators

Five tuned helical resonators (L2351/L2352 through L2359/L2360) provide the RF

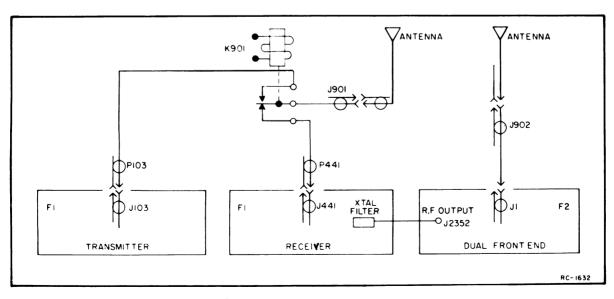


Figure 3 - Dual Antenna Block Diagram

selectivity in the dual front end. An RF cable connects the RF signal from the antenna to a tap on L2351/L2352. The tap is positioned to provide the proper impedance match to the antenna. The output of L2359/L2360 is coupled through C3 to the 1st mixer assembly.

#### 1st Oscillator and Multiplier (A2355-A2358)

The receiver 1st oscillator operates in a transistorized Colpitts oscillator circuit. The oscillator crystal operates in a fundamental mode at a frequency of approximately 13 to 18 megahertz. The crystal is cut to provide temperature compensation at the high end of the temperature range and is thermistor compensated at low temperatures. This provides ±.0005% frequency stability as soon as the receiver is energized -- without having to wait for crystal ovens to warm up.

Regulated 10 volts is supplied to the crystal circuit to forward bias diode CR1. Forward biasing the diode reduces its impedance, so that the crystal frequency is applied to the base of oscillator transistor Q1. Feedback for the oscillator is developed across C21. The oscillator output is coupled through C24 to the base of 1st multiplier Q2.

The output of the 1st multiplier (tripler Q2) is transformer-coupled (T1/T2) to the 2nd multiplier assembly. The 1st multiplier centralized metering jack J2351-4 through metering network CR5, R5, R16 and C32.

#### 2nd Multiplier (A2353/A2354)

The 1st multiplier output is transformer coupled through T1/T2 to the base of 2nd multiplier A2353. Following the 2nd multiplier are three resonant L-C circuits tuned to nine times the crystal frequency. The output is taken from a tap on L311/L312 and applied to the 1st mixer.

#### lst Mixer (A2351/A2352)

The 1st mixer uses a Field-Effect Transistor (FET) as the active device. The FET may be considered a semiconductor current path (or channel) whose resistance is varied by a voltage applied to the control element (gate). Lead identification for the FET is shown in Figure 4.

The FET has several advantages over a conventional transistor, including a high input impedance, high power gain, and an output that is relatively free of harmonics (low in intermodulation products). The FET also has voltage-controlled characteristics, and may be compared to a vacuum tube in operation (see Figure 4).

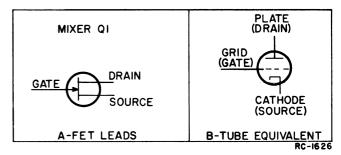


Figure 4 - FET Nomenclature

In the 1st mixer, RF from the helical resonators is applied to the gate of Ql, and injection voltage from and 2nd multiplier is applied to the source. The mixer output is taken from the drain and applied to the output transformer. The transformer is tuned to the 5.3 MHz high IF frequency.

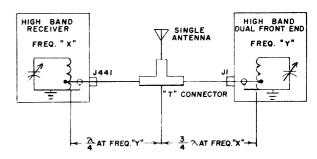
#### HI IF Amplifier (A2365)

A series-resonant circuit (L3 and C1) couples the mixer output to the emitter of high IF amplifier Q1. The transistor operates as a grounded-base amplifier which provides a low impedance for the mixer input. The amplifier output is coupled through transformer T1 to the crystal filter on the receiver.

Centralized metering jack J2351 is provided for maintenance and alignment of the lst multiplier. The four leads from receiver plug P443 supplies the regulated 10 volts for the Dual Front End circuit, crystal switching, system negative, and ground connections.

#### RF CABLE LENGTHS

When changing frequencies or units in single antenna systems, the RF cables from the "T" connector to the receiver and DFE must be cut to the lengths calculated from the "Cable Length Chart" (Figure 5). This is particularly important when F1 and F2 are only a few channels apart.



(19A121702, Sh. 3, Rev. 2)
Figure 5 - Cable Lengths for Single
Antenna Systems

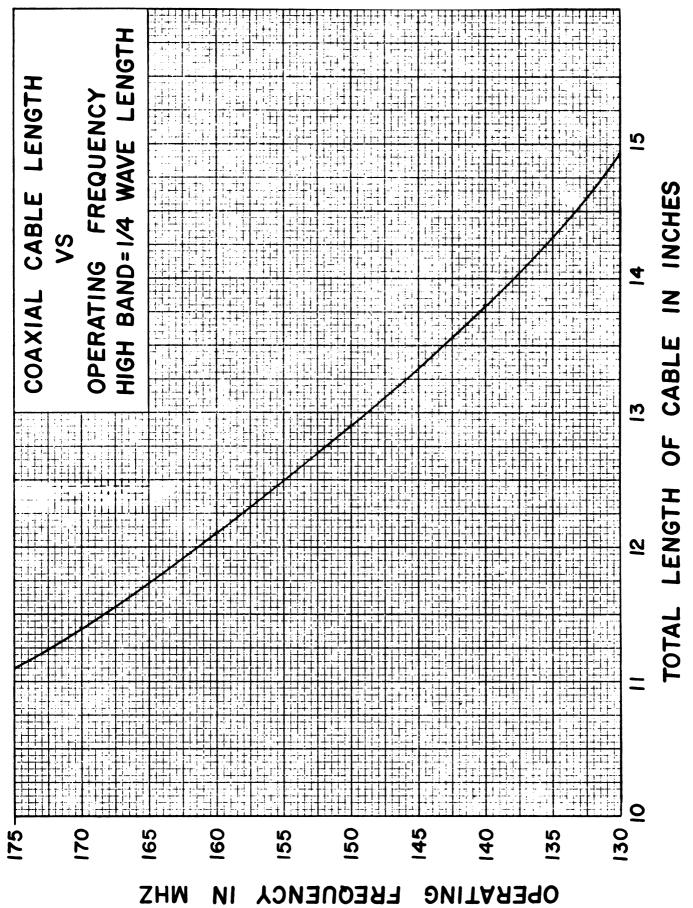
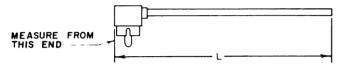


Figure 6 - Cable Length Chart

#### Procedure

Prepare the one-quarter wavelength coaxial cable to connect the receiver to the "T" connector as follows:

- 1. From Figure 6, determine the proper length for the receiver cable by using the <u>Dual Front End</u> frequency.
- 2. Subtract four inches from the length found in Step 1 (for the length of cable inside the receiver). This gives you the cutting length for the cable.
- 3. Measure the cable as shown in Figure 7 and cut the cable to length.



(19A121772, Sh. 1, Rev. 1)
Figure 7 - Receiver Cable Length
(1/4-Wavelength at DFE Freq.)

4. Strip the cable as shown in Figure 8 and solder the phono-type connector onto the cable as shown in Figure 9. Be sure that the center conductor is even with the tip of the phono connector.



(19A121772, Sh. 2, Rev. 0)

Figure 8 - Stripping Lengths for Receiver Cable

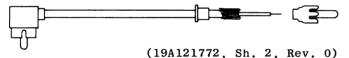


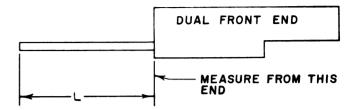
Figure 9 - Assembling Phono Connector on Receiver Cable

5. Plug the cable from J441 on the receiver to the "T" connector. Replace the cable beneath the cable clamp.

Prepare the three-quarter wavelength coaxial cable to connect the Dual Front End to the "T" connector as follows:

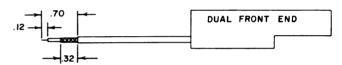
1. From Figure 6, determine the value of one-quarter wavelength at the receiver frequency. Multiply this by three to find three-quarter wavelength. This gives you the cutting length for the Dual Front End cable.

Measure the cable as shown in Figure 10 and cut the cable to length.



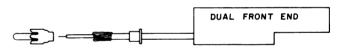
(19A121772, Sh. 1, Rev. 1) Figure 10 - DFE Cable Length (3/4-Wavelength at Rcvr Freq.)

3. Strip the cable as shown in Figure 11 and solder the phono connector onto the cable as shown in Figure 12. Be sure that the center conductor is even with the tip of the phono conductor.



(19A121772, Sh. 2, Rev. 0)

Figure 11 - Stripping Lengths for DFE Cable



(19A121772, Sh. 2, Rev. 0)
Figure 12 - Assembling Phono Connector on
DFE Cable

#### **MAINTENANCE**

#### DISASSEMBLY

Removing Dual Front End and/or Search-Lock Monitor:

#### Dual Front End

- Pull locking handle down and pull radio out of mounting frame.
- Remove the four screws holding back cover to system frame. Slide cover back and lift off (see Figure 13).
- Remove four screws from angle brackets holding Dual Front End to the system frame.
- Carefully swing Dual Front End chassis out for servicing.

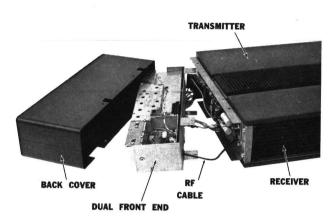


Figure 13 - Dual Front End Disassembly

## TEST PROCEDURES

# Dual Front End

SYMPTOM	СНЕСК
No Output	<ol> <li>Connections to P443.</li> <li>Cable from J2352 to receiver mixer board.</li> </ol>
	<ol> <li>Antenna terminal connections.</li> </ol>
	4. Check 10-volt supply with GE test meter at pin 13 on DFE centralized metering jack J2351.
Low	l. DFE alignment.
Sensitivity	<ol><li>Cable and relay connections.</li></ol>
	3. 1st Mixer Ql voltages.
	4. lst Oscillator Q1 volt- ages.
	<ol><li>HI IF Amplifier Ql volt- ages.</li></ol>
Low	1. Oscillator alignment.
Oscillator Reading	<ol><li>Voltage readings at 1st Oscillator Ql.</li></ol>
	3. Crystal Yl.

## **DUAL FRONT END ALIGNMENT**

Refer to Receiver MAINTENANCE MANUAL for Receiver IF Alignment Procedure.

## **EQUIPMENT REQUIRED**

- 1. GE Test Set Models 4EX3A10 or 4EX8K10,11 (or a 20,000 ohm-per-volt multimeter).
- 2. Signal Generator (132-174 MHz range). Connect a one-inch piece of insulated wire no larger than .065-inch diameter to generator output probe.

## PRELIMINARY CHECKS AND ADJUSTMENTS

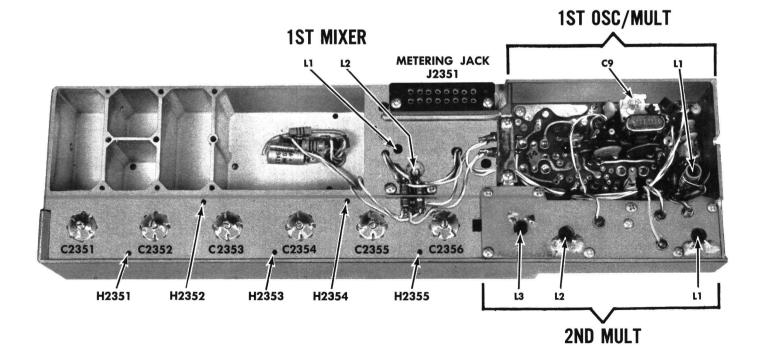
- 1. Plug Test Set cable into metering jack J2351. With Test Set in position J, check for regulated +10 volts. If using multimeter, measure at metering jack J2351-13 and -16.
- 2. If using Multimeter for alignment, connect positive lead to J2351-16 (ground).
- 3. Set frequency selector switch on control unit to F2 position.
- 4. Set crystal trimmer C9 (on 1st Osc/Mult) to mid-capacity.

— NOTE -

If Receiver and Dual Front End operating frequencies are less than 1 MHz apart, connect the signal generator directly into the the Dual Front End antenna connector J1, not into the "T" connector.

## ALIGNMENT PROCEDURE

	METERING	POSITION								
		Multimeter		METER						
STEP	GE Test Set	- at J2351	TUNING CONTROL	READING	PROCEDURE					
OSCILLATOR, MULTIPLIERS & 1ST MIXER										
1.	D (Mult 1 on DFE)	Pin 4	L1 (on 1st OSC/MULT), and L1 (on 2nd MULT)	Switch Test Set to Test 1 or 1-volt position. Tune L1 on 1st OSC/MULT for maximum meter reading. Then tune L1 on 2nd Mult for minimum meter reading.						
2.	E (Mult 2 on DFE)	Pin 5	L1 (on 1st OSC/ MULT), and L1, L2 and L3 (on 2nd MULT)	See Procedure	Tune L1 on 1st OSC/MULT and L1 and L2 on 2nd MULT for maximum meter reading. Then tune L3 for minimum meter reading.					
3.	A (Disc on Receiver)	Pin 10		Zero	Connect Test Set plug to receiver meter; jack J442. Insert signal generator prolinto H2355 and adjust signal generator discriminator zero.					
4.	B (2nd IF Amp on Receiver)	Pin 2	L1 and L2 (on 1st Mixer)	Maximum	Apply an on-frequency signal as above. Tune L1 and L2 for maximum meter reading, keeping signal below saturation.					
			RF CI	RCUITS						
5.	B (2nd IF Amp on Receiver)	Pin 2	C2356, C2355, C2354, C2353 and C2352	Maximum	Apply an on-frequency signal onto the holes as shown below. Insert probe into hole only deep enough to obtain a reading.					
					Insert Prove Into:     Tune:       1. H2355     C2356       2. H2354     C2355       3. H2353     C2354       4. H2352     C2353       5. H2351     C2352					
6.	B (2nd IF Amp on Receiver)	Pin 2	C2351 thru C2356	See Procedure	Apply an on-frequency signal to antenna jack Jl. Tune C2351 thru C2356 for maximum meter reading, keeping signal below saturation. Then retune C2351 thru C2356 slightly for maximum quieting.					
FREQUENCY ADJUSTMENT										
7.	A (Disc on	Pin 10	C9 (on 1st OSC/MULT)	Zero	Apply an on-frequency signal to antenna jack Jl, and adjust C9 for zero discriminator reading					



Receiver)

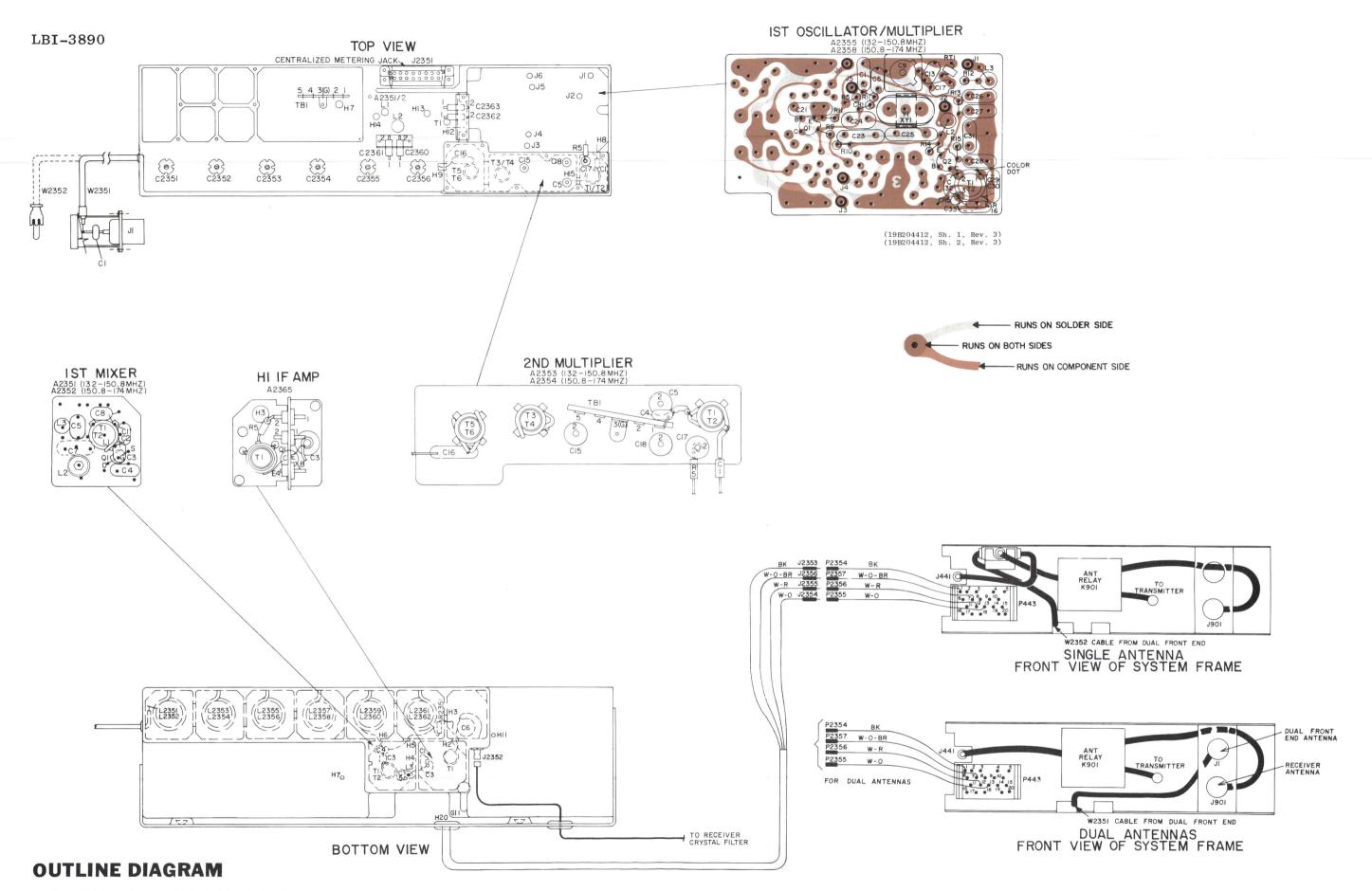
# **ALIGNMENT PROCEDURE**

nator reading.

LBI-3890

132—174 MHz, DUAL FRONT END 19D413151-G1 thru G4

Issue 2



132—174 MHz, DUAL FRONT END 19D413151-G1 thru G4

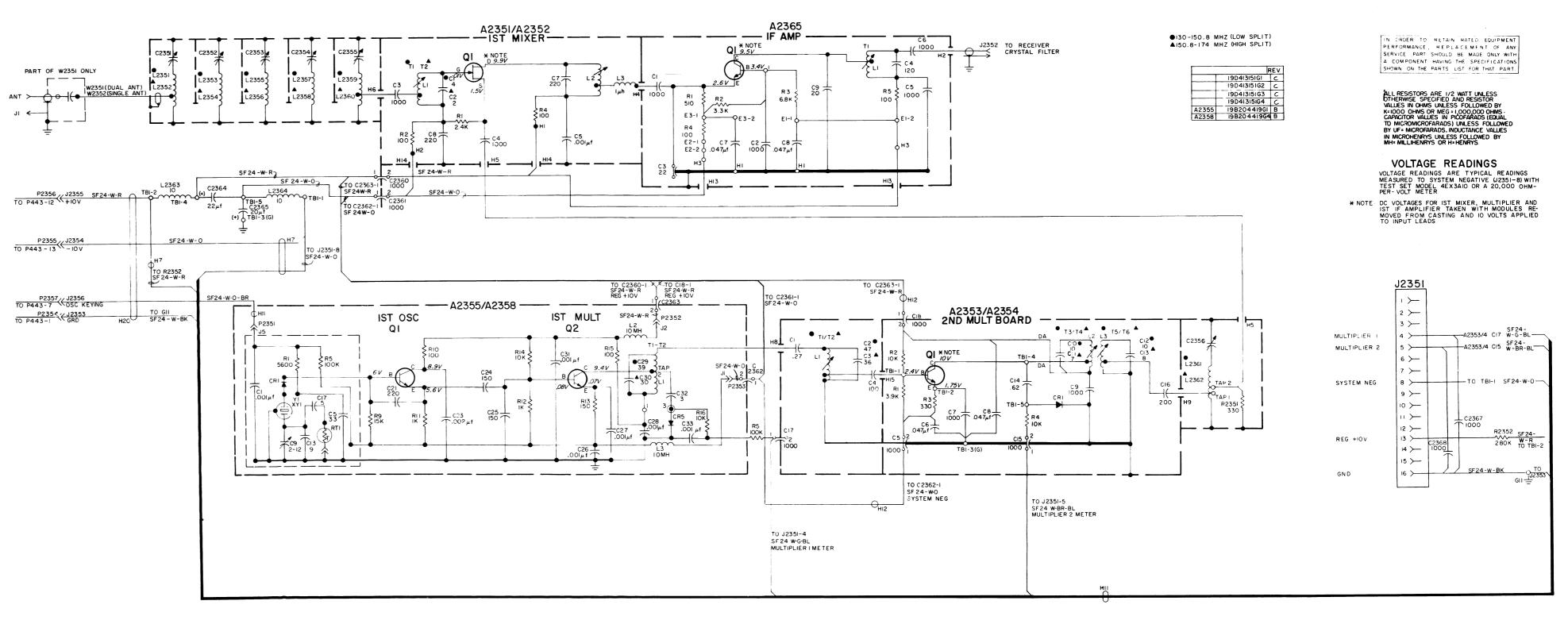
(19R621241, Rev. 1)

#### PARTS LIST

YMBOL	G-E PART NO.	DESCRIPTION			
2351		FIRST MIXER			
nd 2352		A2351 19B216077-G1 A2352 19B216077-G2			
C1		(Part of T1).			
C2		(Part of T2).			
C3		(Part of Tl and T2).			
C4	5494481-Pl1	Ceramic disc: .001 µf ±20%, 1000 VDCW; sim to RMC Type JF Discap.			
C5*	5494481-P112	Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap. Earlier than REV A:			
	5491189-P1	Polyester: .01 µf ±20%, 50 VDCW.			
C6*	5490446-P2	Variable, ceramic: approx 5 to 25 pf, 350 VDCW, temp coef 0 PPM; sim to Erie Style 557-36. Deleted by REV C:			
C7*	7489162-P35	Silver mica: 220 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15. Earlier than REV C:			
	5496218-P254	Ceramic disc: 43 pf ±5%, 500 VDCW, temp coef -80 PPM.			
C8 and C9	5491601-P130	Phenolic: 3.3 pf ±5%, 500 VDCW.			
		INDUCTORS			
L1		(Part of Tl and T2).			
L2*	19B216576-Gl 19A127115-G1	Coil. Earlier than REV C: Coil.			
L3	7488079-P6	Choke, RF: 1 µh ±10%, 0.3 ohm DC res max; sim to Jeffers 4411-8.			
		TRANSISTORS			
Q1	19Al15953-P1	N Channel, field effect.			
		RESISTORS			
Rl	3R152-P242J	Composition: 2400 ohms ±5%, 1/4 w.			
R2	3R152-P101K	Composition: 100 ohms ±10%, 1/4 w.			
R3*	3R152-P103K	Composition: 10,000 ohms ±10%, 1/4 w. Deleted by REV C:			
R4	3R 15 2-P101K	Composition: 100 ohms ±10%, 1/4 w.			
T1 and T2		COIL ASSEMBLY T1 19B216100-G1 T2 19B216100-G2			
Cl	5496218-P235	Ceramic disc: 4.0 pf ±5%, 500 VDCW, temp coef -80 PPM.			
C2	5491238-P12	Ceramic disc: 2 pf ±0.25 pf, 500 VDCW, temp coef -80 ±120 PPM.			
СЗ	5494481-P11	Ceramic disc: .001 µf ±20%, 1000 VDCW; sim to RMC Type JF Discap.			
		INDUCTORS			
Ll	19B216100-P6	Coil. Includes tuning slug 5493185-P5.			
2353		SECOND MULTIPLIER			
nd 2354		A2353 19B216107-G1			
		A2354 19B216107-G2			
		(Cont'd on page 10)			

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LBI-3889A



(19R621237, Rev. 5)

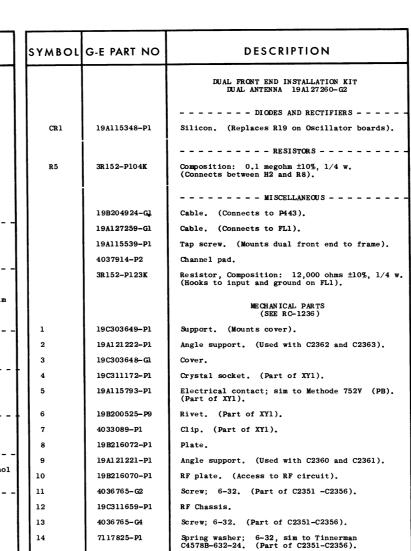
# **SCHEMATIC DIAGRAM**

132—174 MHz, DUAL FRONT END 19D413151-G1 thru G4

\*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES. Issue 2

# LBI-3890

BI-389	)													
(Cont'd	from page 9) (LBI-3	3889)		<del></del>	T		1	1		<del></del>				
SYMBO	L G-E PART NO	DESCRIPTION	SYMBOL	G-E PART NO	DESCRIPTION	SYMBOL	G-E PART NO	DESCRIPTION	SYMBO	OL G-E PART NO	DESCRIPTION	SYMBOL	G-E PART NO	DESCRIPTION
			1		DIODES AND RECTIFIERS			resistors	C7	19B209243-P105	Polyester: 0.047 µf ±10%, 50 VDCW.	L2356	19B216110-P1	Coil,
C1		(Part of Tl and T2).	CR1	19A115250-P1	Silicon.	R1	3R152-P562J	Composition: 5600 ohms ±5%, 1/4 w.	and C8	İ		L2357	19B216110-P2	Coil.
C2		(Part of T1).		5491798-P5	Tuning slug.	R9	3R152-P153J	Composition: 15,000 ohms ±5%, 1/4 w.	C9	1	(Part of T1).	L2358	19B216110-P1	Coil.
СЗ		(Part of T2).	T5 and		COIL ASSEMBLY T5 19B216102-G1	R10	3R152-P101K	Composition: 100 ohms ±10%, 1/4 w.				L2359	19B216110-P6	Coil
C4	j	(Part of Tl and T2).	Т6	İ	T6 19B216102-G2	R11 and	3R152-P102J	Composition: 1000 ohms ±5%, 1/4 w.	El	40 29 30 9-P1	Feed-thru: 750 VRMS max, 5.5 amps; sim to	L2360 L2361	19B216112-G5 19B216112-G2	Coil.
C5	5493392-P7	Ceramic, feed-thru: .001 µf +100% -0%, 500 VDCW; sim to Allen Bradley Type FA5C.				R12			thru E4		Sealectro FT-SM-27.	L2362	19B216112-G1	Coil.
C6	19B209243-P105	Polyester: 0.047 µf ±10%, 50 VDCW.	C12	5496218-P241	Ceramic disc: 10 pf ±5%, 500 VDCW, temp coef -80 PPM,	R13	3R152-P151J	Composition: 150 ohms ±5%, 1/4 w.			IN DUCTORS	L2363	7488079-P16	Choke, RF: 10 μh ±10%, 0.6 ohm DC res max;
C7	5494481-P11	Ceramic disc: .001 µf ±20%, 1000 VDCW; sim to RMC Type JF Discap.	C13	5496218-P239	Ceramic disc: 8.0 pf ±5%, 500 VDCW, temp	R14 R15	3R152-P103J 3R152-P101K	Composition: 10,000 ohms ±5%, 1/4 w.  Composition: 100 ohms ±10%, 1/4 w.	Ll		(Part of Tl).	and L2364		sim to Jeffers 4421-7.
C8	19B209243-P105	1			coef -80 PPM.	R16	JR132-F101R	(Part of Tl and T2).		į	TRANSISTORS			
C9	4	(Part of T3 and T4).	C16	5496218-P770	Ceramic disc: 200 pf ±5%, 500 VDCW, temp coef -750 PPM.	R19	3R152-P360J	Composition: 36 ohms ±5%, 1/4 w.	Q1	19A115666-P1	silicon, NPN.	P2351 thru	40 29 840-P2	Contact, electrical; sim to Amp 42827-2.
C10		(Part of T3).		5491798-P5	Tuning slug.		l	THERMISTORS			RESISTORS	P2353		
C11		(Part of T4).	1		TERMINAL BOARDS	- RT1	19B209284-P5	Disc: 43 ohms nominal, color code green.	ħ1	3R152-P511J	Composition: 510 ohms ±5%, 1/4 w.	R2351	3R152-P331K	
C12	1	(Part of T5).	TBl	7487424-P7	Miniature, phen: 4 terminals.	"		biso. Io ones nominal, color code green.	R2	3R 15 2-P33 2K	Composition: 3300 ohms ±10%, 1/4 w.	R2351	5495948-P444	Deposited carbon: 280,000 ohms ±1%, 1/2 w; sim
C13		(Part of T6),	A2355		FIRST OSCILLATOR				R3	3R152-P682K	Composition: 6800 ohms ±10%, 1/4 w.			to Texas Instrument CD1/2MR.
C14	5491601-P16	Phenolic: 0.62 pf ±10%, 500 VDCW; sim to Quality Components Type MC.	and A2358		A2355 19B204419-G1 Rev B A2358 19B204419-G4 Rev B	T1 and T2	ļ	COIL ASSEMBLY T1 19B204421-G1 T2 19B204421-G2	R4	3R152-P101K	Composition: 100 ohms ±10%, 1/4 w.	1	:	TERMINAL BOARDS
C15	5493392-P7	Ceramic, feed-thru: .001 µf +100% -0%, 500 VDCW; sim to Allen Bradley Type FA5C.		İ			i	12 170201121-02	R5		(Part of T1).	TB1	7487424-P7	Miniature, phen: 4 terminals.
C16		(Part of T5 and T6).	C1	5494481-P112	Committee discussion and the discussion of the committee discussion and th		1				TRAN SFORMERS			
C17	5493392-P7	Ceramic, feed-thru: .001 \( \mu f + 100\%-0\%, \) 500 VDCW;	"	5494481-P112	Ceramic disc: .001 $\mu$ f $\pm$ 10%, 1000 VDCW; sim to RMC Type JF Discap.	C29	5496218-P253	Ceramic disc: 39 pf ±5%, 500 VDCW, temp coef -80 PPM.	т1		COIL ASSEMBLY 19B216103-G1	W2351		CABLE ASSEMBLY
and Cl8		sim to Allen Bradley Type FA5C.	C5	5496219-P751	Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef -750 PPM.	C30	5496218-P250	Ceramic disc: 30 pf ±5%, 500 VDCW, temp coef -80 PPM.			19B210103-W			19B204930-G1
		INDUCTORS	C9	5491271-P106	Variable, subminiature: approx 2.1-12.7 pf	C32	5496218-P34	Ceramic disc: 3 pf ±0.25 pf, 500 VDCW, temp						
ы		(Part of Tl and T2).	C13	5496219-P40	750 v peak; sim to EF Johnson 189-6-5.			coef 0 PPM.	C4	5496 21 8-P265	Ceramic disc: 120 pf ±5%, 500 VDCW, temp coef -80 PPM.	C1	19B209141-P1	Ceramic disc: .001 µf ±10%, 500 VDCW.
L2		(Part of T3 and T4).	"	3450215-P40	Ceramic disc: 9 pf ±0.25 pf, 500 VDCW, temp coef 0 PPM.	C33	5494481-P12	Ceramic disc: .001 µf ±10%, 1000 VDCW; sim to RMC Type JF Discap.	C5	5494481-P111	Ceramic disc: .001 µf ±20%, 1000 VDCW; sim to RMC Type JF Discap.			
L3		(Part of T5 and T6).	C17	19C300685-P93	Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM.		1	DIODES AND RECTIFIERS	C6	5494481-P11	Ceramic disc: .001 µf ±20%, 1000 VDCW; sim to	J1	2R22~P3	Receptacle: coaxial, 1 contact; sim to Amphenol 83-1R.
		TRANSISTORS	C21	5496219-P771	Ceramic disc: 220 pf ±5%, 500 VDCW, temp coef	CR5	19A115250-P1	Silicon.			RMC Type JF Discap.			MI SCELLANEOUS
ðī	19Al15330-Pl	Silicon, NPN.	C23	5494481-P114	-750 PPM.  Ceramic disc: .002 µf ±10%, 1000 VDCW; sim to	11			C9	5496218-P246	Ceramic disc: 20 pf ±5%, 500 VDCW, temp coef -80 PPM.		19B204398-P3	Can.
					RMC Type JF Discap.	Lı	19A121093-P1	Coil. Includes tuning slug 5491798-P5.			RESISTORS		19A121436-P1	Cap.
R1	3R 15 2-P39 2K	Composition: 3900 ohms ±10%, 1/4 w.	C24	5490008-P31	Silver mica: 150 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.		15/12/05-27	coll. Includes tuning stag 0301130-10.	R5	3R152-P101K	Composition: 100 ohms ±10%, 1/4 w.	W2352	19B209044-P19	Cable, RF: approx 4 feet.
R2	3R 152-P103K	Composition: 10,000 ohms ±10%, 1/4 w.	C25	5496219-P467	Ceramic disc: 150 pf ±5%, 500 VDCW, temp coef -220 PPM,			RESISTORS	11		CHASSIS AND RF CIRCUIT			DUAL FRONT END INSTALLATION KIT
R3	3R152-P331K	Composition: 330 ohms ±10%, 1/4 w.	C26	5494481-P112	Ceramic disc: .001 µf ±10%, 1000 VDCW; sim to	R16	3R152-P103K	Composition: 10,000 ohms ±10%, 1/4 w.			19D413151-GL thru G4			SINGLE ANTENNA 19A127260-G1
R4	3R152-P103K	Composition: 10,000 ohms ±10%, 1/4 w.	thru C28	1	RMC Type JF Discap.			SOCKETS						DIODES AND RECTIFIERS
R5	3R152-P104K	Composition: 0.1 megohm ±10%, 1/4 w.	C29	1	(Part of T1).	XY1		Refer to Mechanical Parts (RC-1637).	C2351		(See mechanical parts, RC-1637).	CR1	19A115348-P1	Silicon.
		TRAN SFORMERS	C30	1	(Part of T2).			CRYSTALS	thru C2356				ļ	RESISTORS
T1		COIL AS SEMBLY T1 198216097-G1	C31	5494481-P112	Ceramic disc: .001 µf ±10%, 1000 VDCW; sim to RMC Type JF Discap.			When reordering give GE Part No. and specify exact freq needed.	C2360 thru	19B209135-P1	Ceramic, feed-thru: 1000 pf +150% -0%, 500 VDCW.	R5	3R 15 2- P1 04 K	Composition: 0.1 megohm ±10%, 1/4 w. (Connects between H2 and R8).
T2		T2 19B216097-G2	C32		(Part of Tl and T2).			Crystal freq = (OF -5.30 MHz) ÷ 9.	C2363			1		(connects between inz and ko).
			C33			¥1	19B206576-P4	Quartz: freq range 14077,777 to 16166.666 KHz,	C2364	54 96 26 7-P1 0	Tantalum: 22 μf ±20%, 15 VDCW; sim to Sprague Type 150D.			MI SCELLANE OUS
C1	5491601-P107	Phenolic: 0.27 pf ±5%, 500 VDCW; sim to Quality Components Type MC.			DIODES AND RECTIFIERS	<sub>Y1</sub>	19B206576-P5	temp range -30°C to +85°C. (132-150.8 MHz)  Quartz: freq range 16166.667 to 18744.444 KHz,	C2365	19A115680-P3	Electrolytic: 20 µf +150% -10%, 2 VDCW; sim to Mallory Type TT.		7104941-P11	Plug, phono: sim to Accurate Al0033-8. (Mounts on RF Cable 5491689-P56).
C2	5496218-P255	Ceramic disc: 47 pf ±5%, 500 VDCW, temp	CR5		(Part of Tl and T2).	"		temp range -30°C to +85°C. (150.8-174 MHz)	C2367	5494481-P12	Ceramic disc: .001 µf ±10%, 1000 VDCW; sim to		5491689-P56	Cable assembly. (Connects between J443 and 19A121321-Pl support).
		coef -80 PPM.			JACKS AND RECEPTACLES	A2365		HIGH IF AMPLIFIER	and C2368		RMC Type JF Discap.		19Al 15324-Pl	Connector adapter. (Connects to W2352 for
СЗ	5496218-P252	Ceramic disc: 36 pf ±5%, 500 VDCW, temp coef -80 PPM.	J1 thru	4033513-P4	Contact, electrical: sim to Bead Chain L93-3.			19B216109-G1			JACKS AND RECEPTACLES	-		single antenna).
C4	5496203-P134	Ceramic disc: 100 pf ±5%, 500 VDCW, temp coef -3300 PPM.	J6					CAPACITORS	11	19B205689-G2	Connector: 18 contacts.		19A121321-P1 19B204924-G1	Support, (Used with 19A115324-P1 connector), Cable, (Connects to P443),
	5491798-P5	Tuning slug.	,,	1		C1	5494481-P11	Ceramic disc: .001 µf ±20%, 1000 VDCW; sim to RMC Type JF Discap.	J2352	19Al 15465-Pl	Connector, coaxial; sim to Micon Electronics Type 1104.		198204924-G1	Cable. (Connects to F443).
			L1 L2	7488079-P16	(Part of Tl and T2).  Choke, RF: 10 $\mu$ h $\pm$ 10%, 0.6 ohm DC res; sim to	C2*	5493392-P107	Ceramic, feed-thru: .001 µf +100%-0%, 500 VDCW;	J2353 thru	7147199-P1	Connector: male contact; sim to Winchester Electronics 21803.		19Al 15539-Pl	Tap screw. (Mounts dual front end to frame).
T3 and T4		COIL ASSEMBLY T3 19B216106-G1 T4 19B216106-G2	and L3	1.555.5-245	Jeffers 4421-7.		5494481-P11	sim to Allen Bradley Type FA5C. Earlier than REV B. Ceramic disc: .001 µf ±20%, 1000 VDCW; sim to	J2356	1	ALCOHAUMED MADOU.		4037914-P2	Channel pad.
'*		14 190210100-02	1	1	TRANSISTORS			RMC Type JF Discap.			INDUCTORS	1	3R152-P123K	Resistor, Composition: 12,000 ohms ±10%, 1/4 w. (Hooks to input and ground on FL1).
			Q1 and	19Al 15330-Pl	Silicon, NPN.	C3	5493392-P108	Ceramic, stand-off: 22 pf ±10%, 500 VDCW; sim to Allen Bradley Type SS5A.	L2351	19B216112-G4	Coil,			-, - ", (moons to input and ground on rul),
C9	5494481-P11	Ceramic disc: .001 µf ±20%, 1000 VDCW; sim to RMC Type JF Discap.	Q2			C4		(Part of T1).	L2352 L2353	19B216112-G3 19B216110-P2	Coil.			
C10	5496218-P241	Ceramic disc: 10 pf ±5%, 500 VDCW, temp coef -80 PPM.		1		thru C6			L2354	19B216110-P2	Co11.			
Cli	5496218-P238	Ceramic disc: 7.0 pf ±5%, 500 VDCW, temp		1					L2355	19B216110-P2	Coil.			
		coef -80 PPM.								-				
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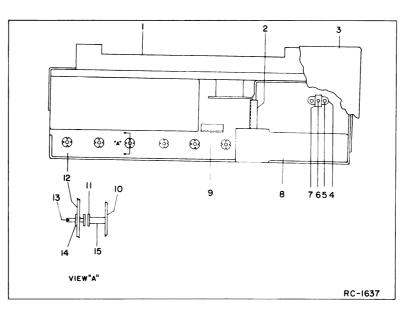
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# PRODUCTION CHANGES

Changes in the equipment to improve performance or to simplify circuits are identified by a "Revision Letter", which is stamped after the model number of the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts List for descriptions of parts affected by these revisions.

- REV. A First Mixer A2351/A2352 (part of chassis and RF circuit  $\overline{198216077\text{-}G1\ \&\ -G2}$ 
  - To incorporate a better high-frequency capacitor. Changed C5.
- REV. B Hi IF Amp A2365 (part of chassis and RF circuit 19B216077-G1
  - To improve stability. Changed C2.
- REV. C First Mixer A2351/A2352 (part of chassis and RF circuit 19B216077-G1 & -G2

  - To improve sensitivity and reduce intermodulation products. Deleted C6 and R3. Changed C7 and L2.



Ceramic insulator: sim to Centralab 3BX845C. (Part of C2351-C2356).

#### **ORDERING SERVICE PARTS**

Each component appearing on the schematic diagram is identified by a symbol number, to simplify locating it in the parts list. Each component is listed by symbol number, followed by its description and GE Part Number.

Service parts may be obtained from Authorized GE Communication Equipment Service Stations or through any GE Radio Communication Equipment Sales Office. When ordering a part, be sure to give:

- 1. GE Part Number of component
- 2. Description of part
- Model number of equipment
   Revision letter stamped on unit

These instructions do not purport to cover all details or variations in equipment nor to provide for every possible contingency to be met in connection with installation, operation or maintenance.

Should further information be desired, or should particular problems arise which are not covered sufficiently for the purchaser's purposes, contact the nearest Radio Communication Equipment Sales Office of the General Electric Company.

## **MAINTENANCE MANUAL**

LBI-3890



MOBILE RADIO DEPARTMENT LYNCHBURG, VIRGINIA 24502
(In Canada, Canadian General Electric Company, Ltd., 100 Wingold Ave., Toronto 19, Ontario)

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